

## **KSC5367F**

### High Voltage and High Reliability

- High speed Switching
- Wide Safe Operating Area
- WWW.DZSC.COM High Collector-Base Voltage



1.Base 2.Collector 3.Emitter WW.DZSC.CO

## **NPN Triple Diffused Planar Silicon Transistor**

### Absolute Maximum Ratings T<sub>C</sub>=25°C unless otherwise noted

Symbol	Parameter	Value	Units
V <sub>CBO</sub>	Collector-Base Voltage	1600	V
V <sub>CEO</sub>	Collector-Emitter Voltage	800	V
V <sub>EBO</sub>	Emitter-Base Voltage	12	V
Ic	Collector Current (DC)	3	А
I <sub>CP</sub>	*Collector Curren (Pulse)	6	A
I <sub>B</sub>	Base Current (DC)	2	A
I <sub>BP</sub>	*Base Current (Pulse)	4	Α
P <sub>C</sub>	Power Dissipation(T <sub>C</sub> =25°C)	40	W
T <sub>J</sub>	Junction Temperature	150	°C
T <sub>STG</sub>	Storage Temperature	- 65 ~ 150	°C

<sup>\*</sup> Pulse Test: Pulse Width=5ms, Duty Cycle≤10%

### Thermal Characteristics T<sub>C</sub>=25°C unless otherwise noted

Symbol	Characteristics		Rating	Unit	
R <sub>θjc</sub>	Thermal Resistance	Junction to Case	3.1	°C/W	
$R_{\theta ia}$		Junction to Ambient	62.5		



## Electrical Characteristics $\rm T_{C}{=}25^{\circ}C$ unless otherwise noted

Symbol	Parameter	Test Condition	Min.	Тур.	Max.	Units
BV <sub>CBO</sub>	Collector-Base Breakdown Voltage	$I_C = 0.5 \text{mA}, I_E = 0$	1600	-	-	V
BV <sub>CEO</sub>	Collector-Emitter Breakdown Voltage	$I_{C} = 5mA, I_{B} = 0$	800	-	-	V
BV <sub>EBO</sub>	Emitter-Base Breakdown Voltage	$I_C = 0.5 \text{mA}, I_C = 0$	12	-	-	V
I <sub>CBO</sub>	Collector Cut-off Current	$V_{CB} = 1,600V, I_{E} = 0$	-	-	20	μΑ
I <sub>EBO</sub>	Emitter Cut-off Current	$V_{EB} = 12V, I_{C} = 0$	-	-	20	μΑ
h <sub>FE1</sub>	DC Current Gain	$V_{CE} = 3V, I_{C} = 0.4A$	12	-	35	
h <sub>FE2</sub>		$V_{CE} = 10V, I_{C} = 5mA$	8	-	-	
V <sub>CE</sub> (sat)	Collector-Emitter Saturation Voltage	$I_C = 250 \text{mA}, I_B = 25 \text{mA}$	-	-	2.5	V
		$I_C = 500 \text{mA}, I_B = 50 \text{mA}$	-	-	4.0	V
		$I_C = 1A, I_B = 0.2A$	-	-	2.5	V
V <sub>BE</sub> (sat)	Base-Emitter Saturation Voltage	$I_C = 500 \text{mA}, I_B = 50 \text{mA}$	-	-	1.5	V
C <sub>ob</sub>	Output Capacitance	$V_{CB} = 10V, I_{E} = 0, f = 1MHz$	-	40	-	pF
t <sub>ON</sub>	Turn On Time	$V_{CC} = 125V, I_{C} = 0.5A$	-	-	0.5	μs
t <sub>STG</sub>	Storage Time	$I_{B1} = 42\text{mA}, I_{B2} = -333\text{mA}$		-	2.2	μs
t <sub>F</sub>	Falling Time	$R_L = 250\Omega$	-	-	0.5	μs
t <sub>ON</sub>	Turn On Time	$V_{CC} = 250V, I_{C} = 1A$	-	-	0.5	μs
t <sub>STG</sub>	Storage Time	$I_{B1} = 0.2A, I_{B2} = -0.4A$	-	-	4.0	μs
t <sub>F</sub>	Falling Time	$R_L = 250\Omega$	-	-	0.5	μs

## **Typical Characteristics**

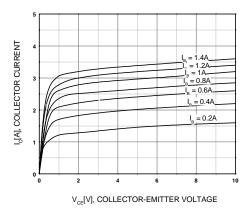


Figure 1. Static Characteristic

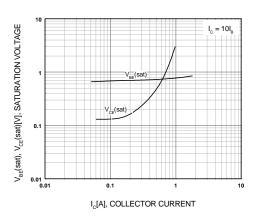


Figure 3. Base-Emitter Saturation Voltage Collector-Emitter Saturation Voltage

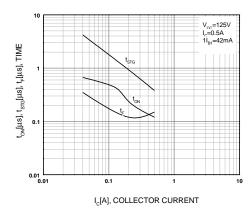


Figure 5. Switching Time

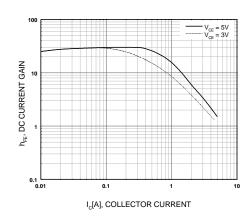


Figure 2. DC current Gain

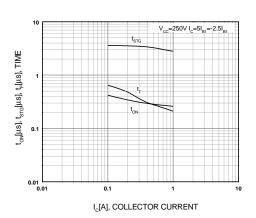


Figure 4. Switching Time

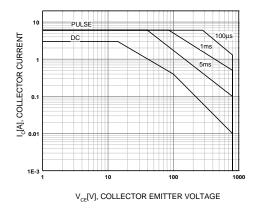


Figure 6. Safe Operating Area

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# Typical Characteristics (Continued)

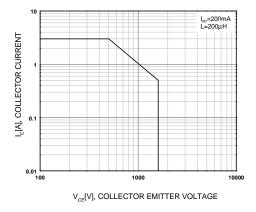


Figure 7. Reverse Bias Safe Operating Area

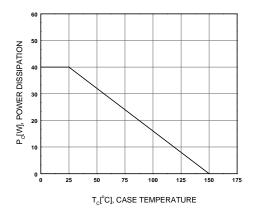
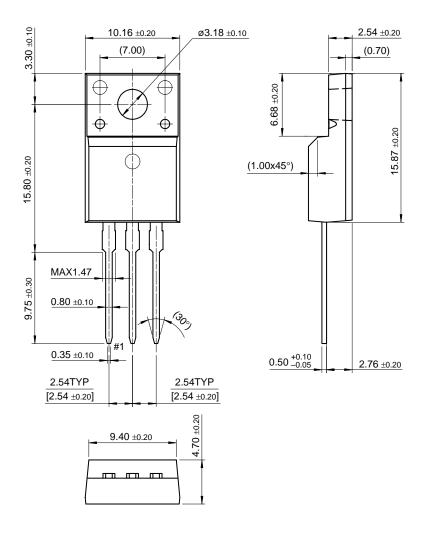


Figure 8. Power Derating

# **Package Dimensions**

# TO-220F



Dimensions in Millimeters

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$CROSSVOLT^{TM}$	FRFET™	MicroPak™	QFET™	SuperSOT™-8
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E2CMOS™	HiSeC™	MSXPro™	Quiet Series™	TruTranslation™
EnSigna™	$I^2C^{TM}$	$OCX^{TM}$	RapidConfigure™	UHC™ _
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